	ES (<u>;</u>	D	OCUMENT	CHANGE REQUEST			
DCR number	206	6 Changes required for: General		neral	Originator: S Thacker (pp Christian			
Date: 2005/10	e: 2005/10/25 Date sent: 2005/10/25				Organisation: ESA/ESTEC			
Status: IMPLEMENTED								
Title:	IC Silicon Monolithic, 32-BIT SPARC Embedded Processor, based on Type TSC695F							
Number:	9512/003 Issue:		lssue:	1				
Other documents affected:								
Page:								
Page 8 Para 1.8 Functional Diagram Page 16, 19, 20, 22, Para1.10 Timing Diagrams Page 31 Para 2.3.1 Room Temperature Electrical Measurements (Input Capacitance) Page 34 Para 2.3.3 Notes to Electrical Measurements Table								
Paragraph:								
Page 8 Para 1.8 Functional Diagram Page 16, 19, 20, 22, Para1.10 Timing Diagrams Page 31 Para 2.3.1 Room Temperature Electrical Measurements (Input Capacitance) Page 34 Para 2.3.3 Notes to Electrical Measurements Table								
Original wording:								
Proposed wording:								
DCR raise on behalf of the Manufacturer Atmel (Christian Ferré: Atmel Aerospace Quality Operations & Chief Inspector)								
See attachment for details.								
1) Para 1.8 Functional diagram - replace diagrams with amended diagram								
2) 3) 4) 5) Para 1.10 Timing diagrams - replace several specific diagrams by corrected versions. Details are as shown in the attachment								
6) Para 2.3.1 Room Temperature Electrical Measurements - Correct maximum limit for Input Capacitance (CI) to be 7pf (was 10pf)								
7) Para 2.3.3 Notes to Electrical Measurements Table Add new note to introduce internal timing parameters, T69 & T70 which are used to facilitate producing timing results related to CLK2 instead of SYSCLK. See attachment for details								
Justification:								



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Status: IMPLEMENT	ΓED		

1), 2), 3), 4), 5), 6), Correction of errors in first issue of the spec

7) The additional note serves to explain T69 & T70, which will be recorded in the data documentation produced for this device, but are parameters without a specified min or max limit and not required to be tested for standard procurement. T69 & T70 were introduced into Atmel's process to satisfy a specific customers request to have the Timing results referenced to CLK2 (instead of SYSCKL as is the standard). The results for T69 & T70 are used together with the standard Timing results to calculate the timings related to CLK2.

Attachments:

Attachment_to_DCR_on_9512003.doc, null

Modifications:

DCR is approved with the following amendment to point 7):

The original wording for point 7 is deleted and replaced with the following:

Page 28 Para. 1.10 Instruction Set and Timing diagrams

Add new timing diagra as attached with title:

SYSCLK to CLK2 Timing

plus note:

"Timings specified with respect to SYSCLK can be specified with respect to CLK2 by means of T69 and T70."

Approval signature:

Date signed:

2005-10-25